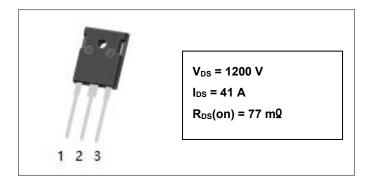
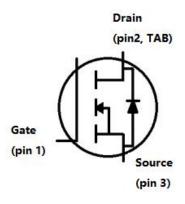


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S2M0080120D 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0080120D is single SiC Power MOSFET packaged in TO-247AD case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0080120D is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 77m^{\text{Q}} .
- Fast switching speed and low switching losses.
- · Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V _{DSS}	V _{GS} = 0V, I _{DS} = 100uA, T _C = 25°C	1200	V
Gate Source Voltage	V _{GSS}	T _C = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to +25	V
Gate Source Voltage	V _{GSOP}	T _C = 25°C Recommended Operational Values	-5 to +20	V
Continuous Drain Current	I _D	V _{GS} = 20V, T _C = 25°C	41	Α
	I _D	V _{GS} = 20V, T _C = 100°C	29	А
Pulsed Drain Current	I _{D,pulse}	T _C =25°C	82	А
Power Dissipation	P _D	T _C =25°C	231	W

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Electrical Characteristics(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit s
Drain Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 1mA	1200			V
Gate Threshold Voltage	.,	$V_{DS} = V_{GS}$, $I_D = 10$ mA	2.0	2.8	4.0	V
	$V_{\text{GS(th)}}$	V _{DS} = V _{GS} , I _D = 10mA, T _J = 175 °C		1.8		V
	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V		0.1	1.0	uA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V, T _J = 175 °C		1		uA
0-4- 0	I _{GSS+}	V _{GS} = 20V, V _{DS} = 0V		10	100	nA
Gate Source Leakage Current	I _{GSS-}	V _{GS} = -5V, V _{DS} = 0V		-10	-100	nA
Drain Source On-State	Б	V _{GS} = 20V, I _D = 20A		77	100	mΩ
Resistance	R _{DS(on)}	V _{GS} = 20V, I _D = 20A, T _J = 175 °C		137		mΩ
Transconductance		V _{DS} = 20 V, I _D = 20 A		10.5		S
	gfs	V _{DS} = 20 V, I _D = 20 A, T _J = 175 °C		8		S
Input Capacitance	Ciss	V _{GS} = 0V,		1324		
Output Capacitance	Coss	V _{DS} = 1000V		74		pF
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV		3.4		
Coss Stored Energy	Eoss	f = 200kHz		37		uJ
Turn-On Switching Energy	Eon	V _{DS} = 800V, V _{GS} = -5/20V		290		
Turn-Off Switching Energy	Eoff	$I_D = 20A, R_{G(ext)} = 2.5\Omega$		20		uJ
Turn-On Delay Time	$t_{d(on)}$	V _{DS} = 800V, V _{GS} = -5/20V		20		
Rise Time	t _r	$I_D = 20A, R_{G(ext)} = 2.5\Omega, L = 975uH$		11		
Turn-Off Delay Time	$t_{\text{d(off)}}$	FWD=S2M0080120D		20		ns
Fall Time	t _f			7.8		
Internal Gate Resistance	R _{G(int)}	f = 1MHz, VAC = 25 mV, D-S short		3.3		Ω
Gate to Source Charge	Q_gs	V _{DS} = 800V, V _{GS} = -5/20V		23		
Gate to Drain Charge	Q_{gd}	I _D = 20A		14		nC
Total Gate Charge	Q_g			54		

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Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5V, I _{SD} = 10A	4.0		V
	V _{SD}	V _{GS} = -5V, I _{SD} = 10A, T _J = 175°C	3.5		V
Continuous Diode Forward Current	Is	V _{GS} = -5V, T _C = 25°C		41	А
Reverse Recovery Time	t _{rr}	V _{GS} = -5V, I _{SD} = 20A, T _J = 25°C	25		ns
Reverse Recovery Charge	Qrr	V _R = 800V	102		nC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 1950A/µs	6.7		Α

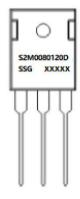
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R ₀ JC	DC operation	0.65	°C/W
Typical Thermal Resistance Junction to Ambient	R _{θJA}		32	°C/W

Ordering Information:

Device	Package	Shipping
S2M0080120D	TO-247AD	25pcs/tube

Marking Diagram



Where XXXXX is YYWWL

S2M = Device Type

 $0080 = R_{DS}(on)$

120 = Reverse Voltage (1200V)

D = Package SSG = SSG YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

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Ratings and Characteristics Curves

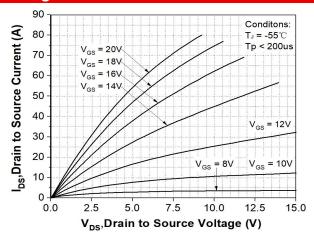


Figure 1. Output Characteristics T_J = -55 °C

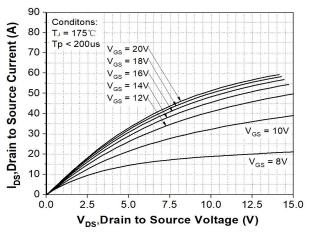


Figure 3. Output Characteristics T_J = 175°C

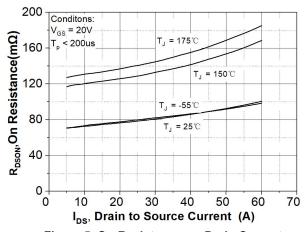


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

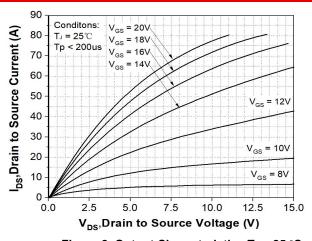


Figure 2. Output Characteristics T_J = 25 °C

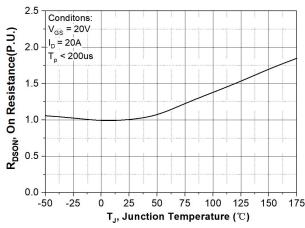


Figure 4. Normalized On-Resistance vs. Temperature

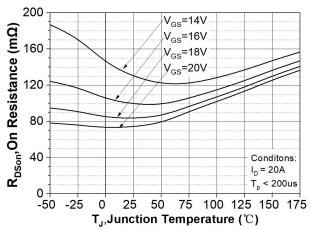


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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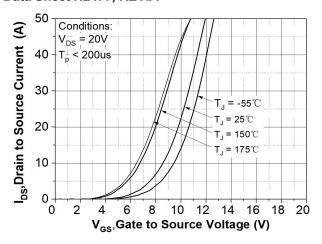


Figure 7. Transfer Characteristic for Various Junction Temperatures

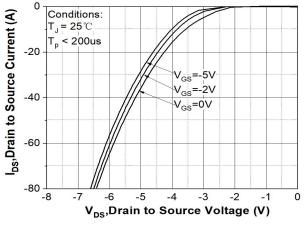


Figure 9. Body Diode Characteristic at T_J = 25 °C

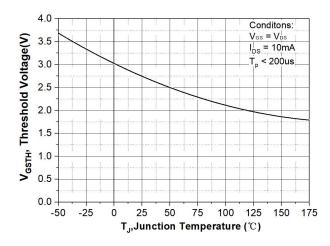
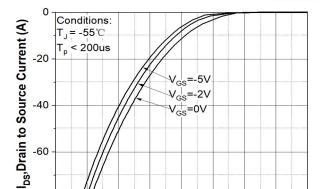


Figure 11. Threshold Voltage vs. Temperature



-80

-8

Figure 8. Body Diode Characteristic at T_J = -55 °C

V_{DS},Drain to Source Voltage (V)

-3

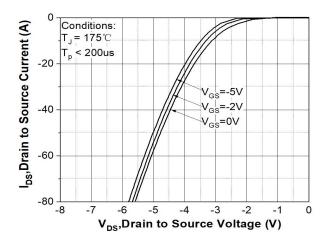


Figure 10. Body Diode Characteristic at T_J = 175 °C

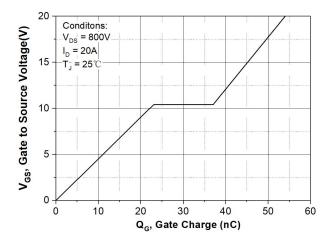


Figure 12. Gate Charge Characteristic

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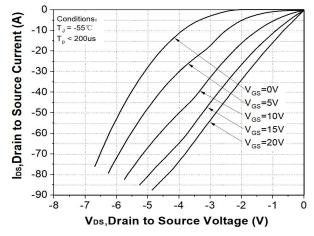


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

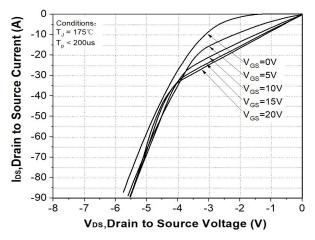


Figure 15. 3rd Quadrant Characteristic at T_J = 175°C

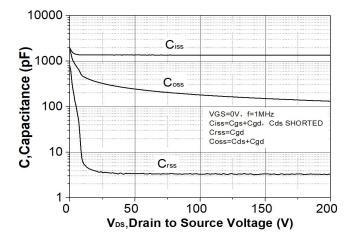


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

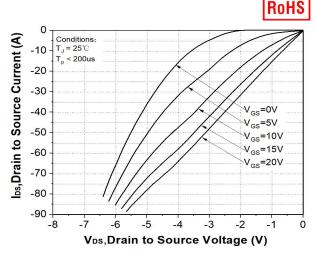


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

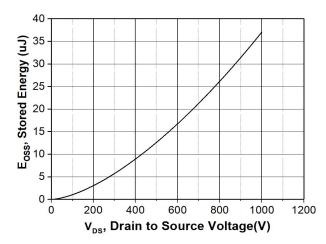


Figure 16. Output Capacitor Stored Energy

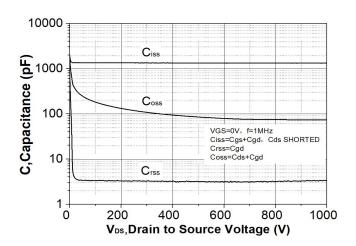


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

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125

150

100



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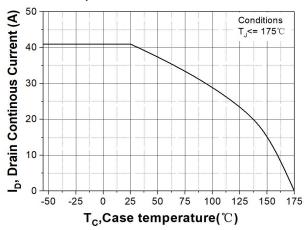


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

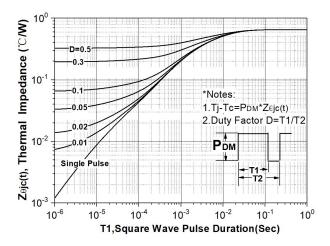


Figure 21. Transient Thermal Impedance (Junction - Case)

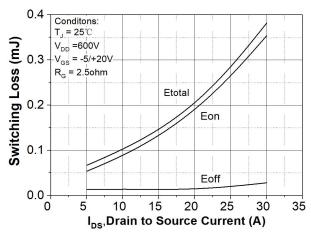


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

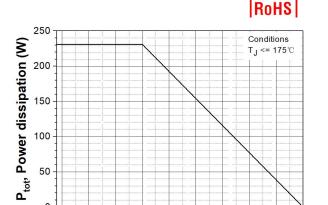


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

50

T_C,Case temperature(°C)

75

-50 -25

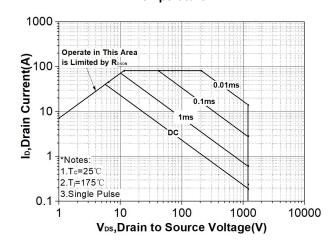


Figure 22. Safe Operating Area

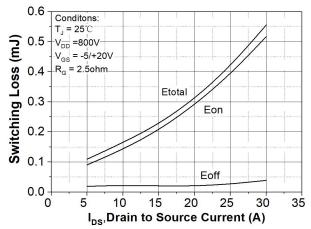


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

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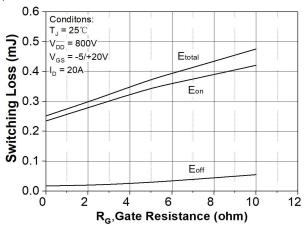


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

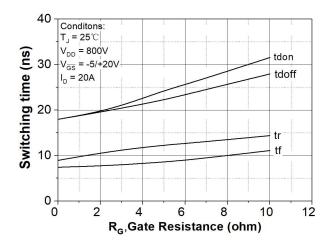


Figure 27. Switching Times vs. R_{G(ext)}

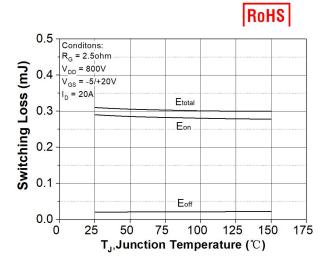


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

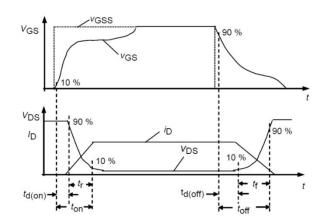
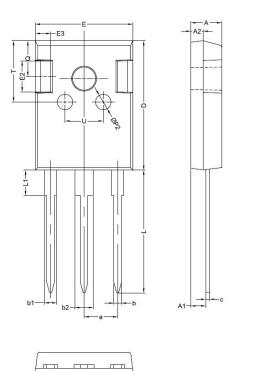


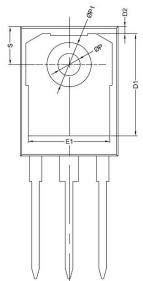
Figure 28. Switching Times Definition

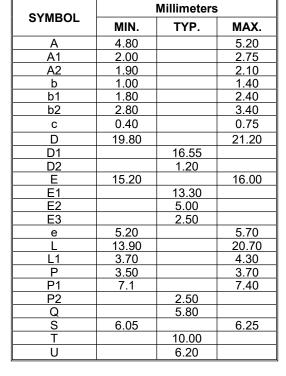




Mechanical Dimensions TO-247AD







S2M0080120D



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